







VTS-1013-N Vacuum Reflow Soldering Machine 9 Heating Zones

Basic Information

Place of Origin: ChinaBrand Name: GS

Model Number: VTS-1013-NMinimum Order Quantity: 1 PCS

• Price: USD+negotiable+pcs

Packaging Details: 700
Delivery Time: 1-7 days
Payment Terms: T/T

Supply Ability: 1+pcs+per days



Product Specification

Model: VTS-1013-N

Overall Dimensions: 6567*1420*1520mm
 Plate Size: 70*50mm-300*350mm

Number Of Heating Zones: 9Length Of Heating Zones: 3420Number Of Cooling Zones: Upper 3

Cooling Method: Water Cooling – External Chiller
 Process Edge: Standard 5mm, Customizable

• Plate Height: 25mm On The Board, 15mm Below The

Board

Condition: Original New

• Highlight: Vacuum Reflow Soldering Machine,

Reflow Soldering Machine Customizable

Vacuum Reflow Soldering Machine Customizable

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| Condition | Original New |

Vacuum Reflow Soldering Features

High vacuum with low bubbles, reducing voids in the soldering surface

High wettability, improving soldering quality

Optimized soldering parameters and processes, enhancing production efficiency

Reduces oxidation and minimizes the risk of cold solder joints

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| Equipment | Length of heating zones | 3420 |
| parameters | Number of cooling zones | Upper 3 |
| | Cooling method | Water cooling – external chiller |
| | Process edge | Standard 5mm, customizable |
| | Plate height | 25mm on the board, 15mm below the board |
| | Transmission mode | Chain |
| Transmission parameters | Transmission control mode | Heating zone and vacuum section servo + cooling zone frequency conversion |
| | Transmission speed | 200-2400mm/min |
| | Transmission height | 900±20 |
| | Transmission direction | L-R or R-L |

| | Number of vacuum zones | 1 |
|--------------------|----------------------------------|---|
| Vacuum | Ultimate vacuum pressure | 10-100pa |
| | Vacuum pumping speed | 60 cubic meters/hour, adjustable |
| | Minimum cycle for vacuum welding | 25Sec (action time can be set) |
| parameters | Release method | Nitrogen quick release |
| | Vacuum chamber operation method | Servo control |
| | Vacuum zone track | Servo width and narrow adjustment |
| | Flux recovery system | Independent vacuum zone recovery device |
| Control parameters | Control mode | PC+Siemens PLC |
| | Temperature control mode | PID+SSR |
| | Temperature control range | Normal temperature -350°C |
| | Temperature control accuracy | ±1°C |
| | Heat-up time | ≤30min |
| | Heat conduction mode | Hot air independent temperature zone circulation, variable frequence speed regulation |
| | Startup/normal operation power | Startup: 45KW, normal operation 15KW |
| | Power failure protection | UPS endurance operation |
| | MES data | Secondary development possible |
| Nitrogen device | Nitrogen filling method | The whole area is filled with nitrogen, and the vacuum area is sampled. |
| | Aviana Remarks | 200 2000 005 0 0 0 |

| | Nitrogen device | Nitrogen filling method | The whole area is filled with nitrogen, and the vacuum area is sampled. |
|--------|--------------------|-------------------------|---|
| device | device | Nitrogen flow rate | 100-1000ppm @35 cubic meters/hour, nitrogen purity 99.999% |



Vacuum Reflow Soldering | GSSMT, Vacuum reflow soldering process, Vacuum soldering machine, Vacuum reflow oven, Solder void reduction, Vacuum soldering technology, Reflow soldering with vacuum, Advanced vacuum soldering, Soldering without voids, Void-free soldering process, Vacuum reflow system, SMT vacuum reflow, High vacuum reflow soldering, Vacuum-assisted reflow soldering, Solder joint void elimination, Vacuum soldering benefits, Vacuum reflow equipment, Industrial vacuum soldering, Low-void reflow soldering, Reflow soldering vacuum chamber, Vacuum soldering applications







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